

SID

Factory: Rot am See

Article:

ML6

Provided:

Saucède, Nicolas

Customer:

VALOTEC

Date:

19.02.2019



Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	
A-RS-FR4-Prepreg-2116-TG135	50200534	102	2	
A-RS-FR4-ML-0.10mm-035+035-TG135	50200265	35	L2	
		100	3	
		35	L3	
A-RS-FR4-Prepreg-1080-TG135	50200442	128	4	
A-RS-FR4-Prepreg-1080-TG135	50200442	0	5	
A-RS-FR4-ML-0.10mm-035+035-TG135	50200265	35	L4	
		100	6	
		35	L5	
A-RS-FR4-Prepreg-2116-TG135	50200534	102	7	
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	

Thickness after Pressing

B00:

690 µm

Tol+:

100 µm

Tol-:

100 µm

Dmax:

790 µm

Dmin:

590 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

800 µm

Tol+:

100 µm

Tol-:

100 µm

Dmax:

900 µm

Dmin:

700 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

708 µm

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